GL4800

Features

- 1. Thin type (Thickness:1.5mm)
- 2. Beam angle ($\Delta \theta$:TYP. $\pm 30^{\circ}$)
- 3. Radiant flux
 - $(\Phi_e:MIN. 0.7mW \text{ at } I_F=20mA)$
- 4. Epoxy resin package

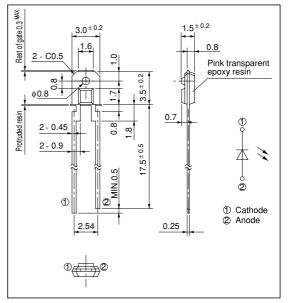
Applications

- 1. Floppy disk drives
- 2. Optoelectronic switches

Thin Type Infrared Emitting Diode

Outline Dimensions

(Unit: mm)



$\begin{array}{c} \textbf{Absolute maximum fattings} & (1_a-23 \text{ C}) \end{array}$						
Parameter	Symbol	Rating	Unit			
Power dissipation	Р	75	mW			
Forward current	I _F	50	mA			
*1 Peak forward current	I _{FM}	1	Α			
Reverse voltage	V _R	6	V			
Operating temperature	T _{opr}	-25 to +85	°C			
Storage temperature	T _{stg}	-40 to +85	°C			
*2 Soldering temperature	T _{sol}	260	°C			

■ Absolute Maximum Ratings $(T - 25^{\circ}C)$

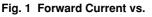
*1 Pulse width≤100µs, Duty ratio=0.01

*2 For 3s at the position of 1.8mm from the surface of resin edge

Electro-optical Characteristics

Electro-optical Characteristics						$T_a=25^{\circ}C)$
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V _F	I _F =20mA	-	1.2	1.4	V
Peak forward voltage	V _{FM}	$I_{FM}=0.5A$	-	3.0	4.0	V
Reverse current	IR	V _R =3V	-	-	10	μΑ
Terminal capacitance	Ct	V _R =0, f=1MHz	-	70	-	pF
Frequency response	f _c	-	-	300	-	kHz
Radiant flux	Φ_{e}	I _F =20mA	0.7	1.6	3.0	mW
Peak emission wavelength	λ _p	I _F =5mA	-	950	-	nm
Half intensity wavelength	Δλ	I _F =5mA	-	45	-	nm

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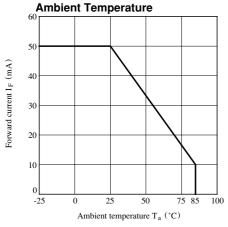


Fig. 3 Spectral Distribution

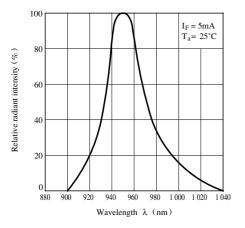


Fig. 5 Forward Current vs. Forward Voltage

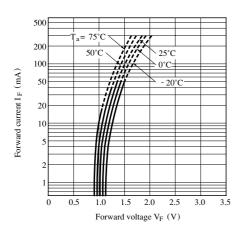


Fig. 2 Peak Forward Current vs. Duty Ratio

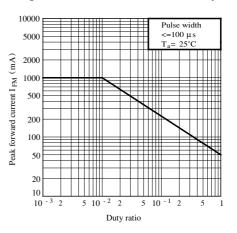


Fig. 4 Peak Emission Wavelength vs. Ambient Temperature

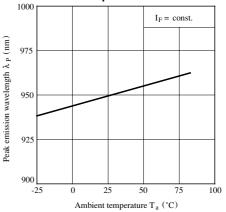


Fig. 6 Relative Radiant Flux vs. Ambient Temperature

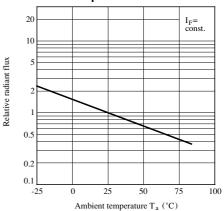
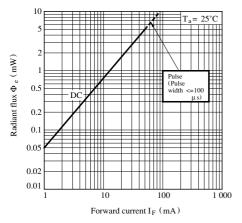
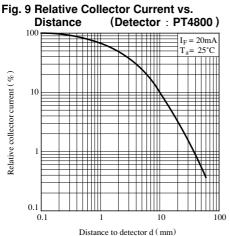
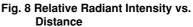


Fig. 7 Radiant Flux vs. Forward Current





• Please refer to the chapter "Precautions for Use."



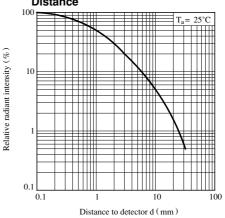
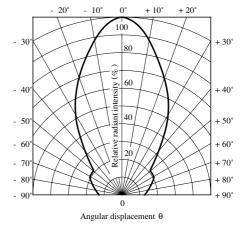


Fig.10 Radiation Diagram $(T_a = 25^{\circ}C)$



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 - --- Gas leakage sensor breakers
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